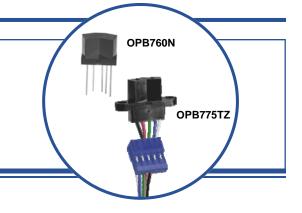


Features:

- · Choice of mounting configurations
- Choice of four output configurations
- .040" (10.160 mm) PCBoard mount (N and T series)
- 12" (304.800 mm) AWG 26 wires (NZ and TZ series)



Description:

The **OPB760N**, **OPB760T**, **OPB770N** and **OPB770T** series of reflective assemblies feature Photologic[®] output. The electrical output can be specified as either TTL Totem-Pole or TTL Open-Collector, either of which can be supplied with inverter or buffer output polarity.

OPB760N and **OPB760T** series devices are designed for PCBoard mounting and have 0.04" (10 mm) long leads. **OPB770N** and **OPB770T** series devices are designed for remote mounting with two mounting tags and have 12" (305 mm) long, UL approved 26 AWG wires.

All devices in this series offer the added stability of a built-in hysteresis amplifier.

Custom electrical, wire and cabling and connectors are available. Contact your local representative or OPTEK for more information.

Applications:

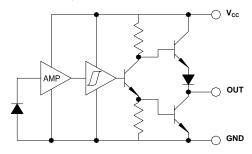
- Non-contact Photologic® reflective object sensor
- · Assembly line automation
- Machine automation
- · Machine safety
- End of travel sensor
- Door sensor

Ordering Information								
Part Number	LED Peak Wavelength	Sensor Photologic®	Reflection Distance (Inch) Min / Max	Mounting	Tabs			
OPB760N		Totem-Pole			No tabs			
OPB761N		Open Collector			2 tabs			
OPB762N		Inv-Totem-Pole	1	PCBoard .40" (10.160 mm) leads)	No tabs			
OPB763N		Inv-Open Collector			2 tabs			
OPB760T		Totem-Pole			No tabs			
OPB761T	Open Collector				2 tabs			
OPB762T		Inv-Totem-Pole		No tabs				
OPB763T	000	Inv-Open Collector	0.000" / 0.000"		2 tabs			
OPB770NZ	890 nm	Totem-Pole	0.080" / 0.220"		No tabs			
OPB771NZ	Open Collector				2 tabs			
OPB772NZ	Inv-Totem-Pole			No tabs				
OPB773NZ		Inv-Open Collector		12" (304.800 mm) 26 AWG wire	2 tabs			
OPB770TZ		Totem-Pole			No tabs			
OPB771TZ		Open Collector			2 tabs			
OPB772TZ		Inv-Totem-Pole			No tabs			
OPB773TZ		Inv-Open Collector			2 tabs			

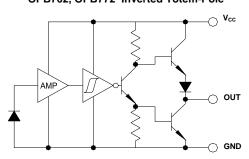




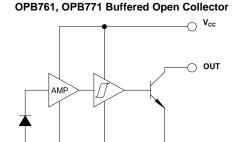
OPB760, OPB770 Buffered Totem-Pole



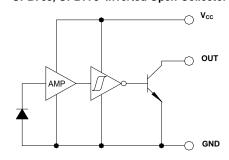
OPB762, OPB772 Inverted Totem-Pole



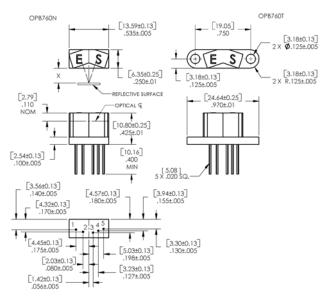
OPB760 (N and T Series)

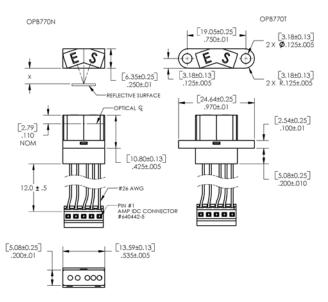


OPB763, OPB773 Inverted Open-Collector



OPB770 (NZ and TZ Series)





X = 0.08" [2.0mm] to 0.22" [5.6mm]

DIMENSIONS ARE IN: [MILLIMETERS]

Pin#	Description	Pin#	Description
1	Cathode	3	Ground
2	Anode	4	Output
		5	V _{cc}

Color/Pin#	Description	Color/Pin#	Description
Red-4	Anode	White-1	V _{CC}
Black-5	Cathode	Blue-2	Output
		Green-3	Ground



Absolute Maximum Ratings (T_A=25°C unless otherwise noted)

Supply Voltage, V _{CC} (not to exceed 3 seconds)	10 V
Storage Temperature Range	-40° C to +85° C
Operating Temperature Range	-40° C to +70° C
Lead Soldering Temperature (1/16" inch (1.6 mm) from case for 5 seconds with soldering iron) ⁽¹⁾	260° C
Input Diode Power Dissipation ⁽²⁾	100 mW
Output Photologic® Power Dissipation ⁽³⁾	200 mW
Total Device Power Dissipation ⁽⁴⁾	300 mW
Voltage at Output Lead (Open Collector Output)	35 V
Diode Forward DC Current	40 mA
Diode Reverse DC Voltage	3 V

Electrical Characteristics (T_A = 25°C unless otherwise noted)

SYMBOL	PARAMETER		TYP	MAX	UNITS	TEST CONDITIONS
Input Diode						
V _F	Forward Voltage	-	-	1.8	V	I _F = 40 mA, T _A = 25° C
I _R	Reverse Current	-	-	100	μΑ	V _R = 2.0 V, T _A = 25° C

Output Photologic® Sensor

V _{CC}	Operating DC Supply Voltage	4.75	-	5.25	V	
I _{CCL}	Low Level Supply Current: Buffered Totem-Pole Output ⁽⁵⁾⁽⁶⁾ Buffered Open-Collector Output ⁽⁵⁾⁽⁶⁾		-	10 10	mA mA	Vcc = 5.25 V, If = 0 mA (output open)
	Inverted Totem-Pole Output ⁽⁵⁾ Inverted Open-Collector Output ⁽⁵⁾	-	-	10 10	mA mA	Vcc = 5.25 V, If = 0 mA (output open)
Іссн	High Level Supply Current: Buffered Totem-Pole Output ⁽⁵⁾⁽⁶⁾ Buffered Open-Collector Output ⁽⁵⁾	-	-	10 10	mA mA	Vcc = 5.25 V, If = 25 mA (output open)
	Inverted Totem-Pole Output ⁽⁵⁾⁽⁶⁾ Inverted Open-Collector Output ⁽⁵⁾⁽⁶⁾	-	-	10 10	mA mA	Vcc = 5.25 V, If = 0 mA (output open)
l _{ОН}	High Level Output Voltage: Buffered Open-Collector Output	-	-	100 100	μΑ μΑ	Vcc = 4.5 V, If = 25 mA, V _{OH} = 30 V, T _A =25°C
	Inverted Open-Collector Output	-	-	100	μΑ	Vcc = 4.5 V, If = 0 mA, V _{OH} = 30 V, T _A = 25°C

Notes:

- (1) RMA flux is recommended. Duration can be extended to 10 seconds maximum when flow soldering.
- (2) Derate linearly 2.22 mW/°C above 25° C.
- (3) Derate linearly 4.44 mW/°C above 25° C.
 (4) Derate linearly 6.66 mW/°C above 25° C.Normal application would be with light source blocked, simulated by I_F=0 mA.
- (5) Tested at d = 0.080" (mm) from a 90% diffuse white test surface.
- (6) Normal application would be with light source blocked, simulated by $I_F = 0$ mA.
- (7) All parameters tested using pulse technique.



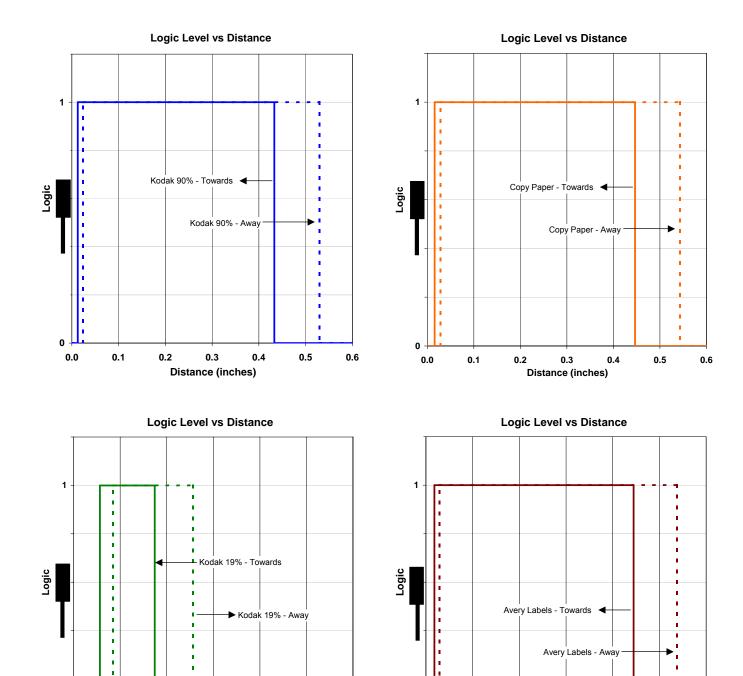
Electrical Characteristics (T_A = 25°C unless otherwise noted)

SYMBOL	PARAMETER	MIN	TYP	MAX	UNITS	TEST CONDITIONS	
Output Phot	Output Photologic® Sensor (continued)						
I _{F(+)}	LED Positive-Going Threshold Current ⁽²⁾	-	-	25	mA	Vcc = 5 V, T _A = 25° C	
I _{F(+)} /I _{F(-)}	Hysteresis ⁽²⁾	1.1	-	2.0	-	Vcc = 5 V	
I _{os}	Short Circuit Output Current: Buffered Totem-Pole Output ⁽¹⁾	-15	-	-100	mA	If = 25 mA, Vcc = 5.25 V, Output = GRD	
	Inverted Totem-Pole Output ⁽¹⁾	-15	-	-100	mA	If = 0 mA, Vcc = 5.25 V, Output = GRD	
V _{OL}	Low Level Output Voltage: Buffered Totem-Pole Output ⁽¹⁾⁽⁴⁾ Buffered Open-Collector Output ⁽¹⁾⁽⁴⁾		-	0.4 0.4	V	V_{CC} = 4.5 V, I_{OL} = 12.8 mA, I_F = 0 mA or I_F = 30 mA	
	Inverted Totem-Pole Output Inverted Open-Collector Output ⁽¹⁾⁽⁴⁾		-	0.4 0.4	V	V _{CC} = 4.5 V, I _{OL} = 12.8 mA, I _F = 25 mA	
	High Level Output Voltage: Buffered Totem-Pole Output ⁽¹⁾	2.4	-	-	٧	V_{CC} = 4.5 V, I_{OH} = -800 μ A, I_F = 25 mA	
V_{OH}	Inverted Totem-Pole Output(1)(4)	2.4	-	-	V	$V_{CC} = 4.5 \text{ V}, I_{OH} = -800 \mu\text{A}, I_{F} = 0 \text{ mA}$	
	Inverted Totem-Pole Output (3) Inverted Open-Collector Output(3)	2.4 2.4	-	- -	V	V_{CC} = 4.5 V, I_{OL} = -800 μ A, I_F = 30 mA	

Notes:

- (1) Tested at d = 0.080" (mm) from a 90% diffuse white test surface.
- Tested at d = 0.080" (mm), 0.150" (mm) and 0.220" (mm) from a 90% diffuse white test surface. Reference: Eastman Kodak, Catalog #E 152 7795.
- Tested at d = 0.080" (mm), 0.150" (mm) and 0.220" (mm) from a 5% diffuse black test surface.
- (4) Normal application would be with light source blocked, simulated by I_E=0 mA.
- OPB760N through OPB763N series devices are terminated with 0.20" (mm) square leads designed for printed PCBoard mounting
- OPB770NZ through OPB773NZ series devices are terminated with 12 inches (mm) of 7-strand 26 AWG UL1429 insulated wire on each terminal. A standard AMP No. 640442-5 connector has been attached to the lead wires to ease connection to wire harnesses.
- (7) OPB760T through OPB763T series devices are terminated with 0.020" (mm) square leads designed for printed PCBoard mounting.
- OPB770TZ through OPB773TZ series are terminated with 12" (mm) of 7-strand 26 AWG UL1429 insulated wire on each terminal. A standard AMP No. 640442-5 connector has been attached to the lead wires to ease connection to wire harnesses.
- (9) All parameters tested using pulse technique.





OPTEK reserves the right to make changes at any time in order to improve design and to supply the best product possible.

0.0

0.1

0.2

0.3

Distance (inches)

0.3

Distance (inches)

0.0

0.1

0.6

0.5



